

Electronic Patent Application Fee Transmittal				
Application Number:	10562236			
Filing Date:	07-Feb-2007			
Title of Invention:	Manufacturing method of silicon wafer			
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Filer:	Stephen M. Roylance/Liping Qi			
Attorney Docket Number:	JG-SU-5222/500577.20072			
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
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Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Submission- Information Disclosure Stmt	1806	1	180	180
Total in USD (\$)				180